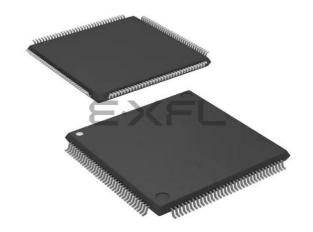
# Lattice Semiconductor Corporation - <u>LFEC1E-5T144C Datasheet</u>



Welcome to **E-XFL.COM** 

# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1500
Total RAM Bits	18432
Number of I/O	97
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec1e-5t144c

Email: info@E-XFL.COM

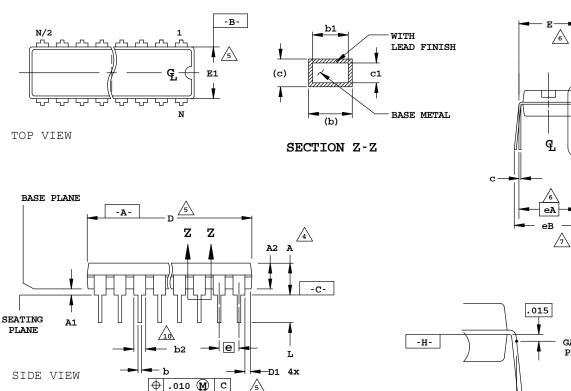
Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

SEE DETAIL



## 20-Pin Plastic DIP Package

### Dimensions in Inches



#### NOTES:

- 1. CONTROLLING DIMENSION: INCH.
- 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M
- 3. DISTANCE BETWEEN LEADS INCLUDING DAMBAR
- PROTRUSIONS TO BE .005 MINIMUM. DIMENSIONS A, A1 & L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING
- PLANE GAUGE GS-3.
- PLANE GAGE GS-3.

  DIMENSIONS D, D1 AND E1
  DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

  MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010

  6 E AND eA MEASURED WITH THE LEADS CONSTRAINED

  TO BE PERPENDICULAR TO DATUM C-
- 70 BE PERPENDICULAR TO DATOM.

  eB AND eC ARE MEASURED AT THE LEAD TIPS

  MITH THE LEADS UNCONSTRAINED. 8 N IS THE MAXIMUM NUMBER OF LEAD
- POSITIONS.

  9. POINTED OR ROUNDED LEAD TIPS ARE PREFERRED TO EASE INSERTION
- 10 b2 MAXIMUM DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSIONS. DAMBAR PROTRUSIONS SHALL NOT EXCEED .010
- 11 DATUM PLANE -H- COINCIDENT WITH THE BOTTOM OF LEAD , WHERE LEAD EXITS BODY

-Н-	GAGE
	→ ← eC

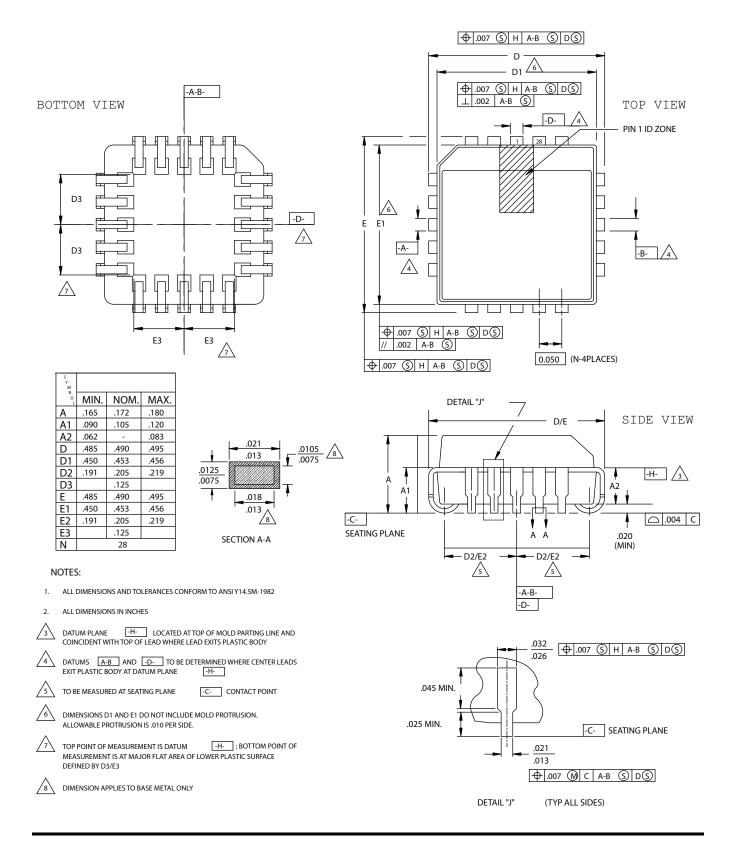
DETAIL A

	N = 20			
s Y M B	I	NCHES		N O T
o L	MIN.	NOM.	MAX.	TE
Α	-	ı	.210	4
A 1	.015	-	-	4
A 2	.115	.130	.195	
b	.014	.018	.022	
b1	.014	.018	.020	
b2	.045	.060	.070	10
С	.008	.010	.014	
C1	.008	.010	.011	
D	.980	1.030	1.060	5
D1	.005	1	-	5
E	.300	.310	. 325	6
E1	.240	.250	.280	5
е	.100 BSC			
еA	.300 BSC			6
eВ	-	-	.430	7
еC	.000	-	.060	7
L	.115	.130	.150	4



### 28-Pin PLCC Package

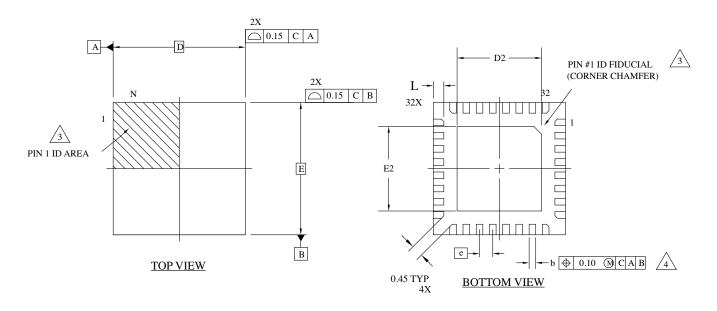
### Dimensions in Inches

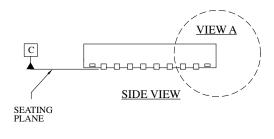


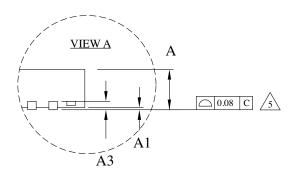


# 32-Pin QFN Package Option 2: MachXO2™

### **Dimensions in Millimeters**







#### NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION 6 APPLIES TO PLATED
TERMINAL AND IS MEASURED BETWEEN
0.15 AND 0.30 mm FROM TERMINAL TIP.

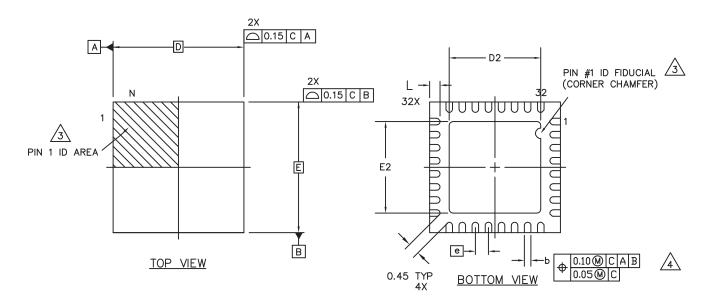
APPLIES TO EXPOSED PORTION OF TERMINALS.

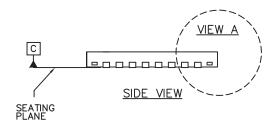
SYMBOL         MIN.         NOM.         MAX.           A         0.50         0.55         0.60           A1         0.00         0.02         0.05           A3         0.2 REF           D         5.0 BSC           D2         3.10         3.20         3.30           E         5.0 BSC           E2         3.10         3.20         3.30           b         0.20         0.25         0.30           e         0.50 BSC           L         0.35         0.40         0.45				
A1 0.00 0.02 0.05  A3 0.2 REF  D 5.0 BSC  D2 3.10 3.20 3.30  E 5.0 BSC  E2 3.10 3.20 3.30  b 0.20 0.25 0.30  e 0.50 BSC	SYMBOL	MIN.	NOM.	MAX.
A3 0.2 REF  D 5.0 BSC  D2 3.10 3.20 3.30  E 5.0 BSC  E2 3.10 3.20 3.30  b 0.20 0.25 0.30  e 0.50 BSC	A	0.50	0.55	0.60
D 5.0 BSC  D2 3.10 3.20 3.30  E 5.0 BSC  E2 3.10 3.20 3.30  b 0.20 0.25 0.30  e 0.50 BSC	A1	0.00	0.02	0.05
D2 3.10 3.20 3.30  E 5.0 BSC  E2 3.10 3.20 3.30  b 0.20 0.25 0.30  e 0.50 BSC	A3	0.2 REF		
E 5.0 BSC  E2 3.10 3.20 3.30  b 0.20 0.25 0.30  e 0.50 BSC	D	5.0 BSC		
E2 3.10 3.20 3.30 b 0.20 0.25 0.30 e 0.50 BSC	D2	3.10	3.20	3.30
b 0.20 0.25 0.30 e 0.50 BSC	Е	5.0 BSC		
e 0.50 BSC	E2	3.10	3.20	3.30
	b	0.20	0.25	0.30
L 0.35 0.40 0.45	e	0.50 BSC		
	L	0.35	0.40	0.45

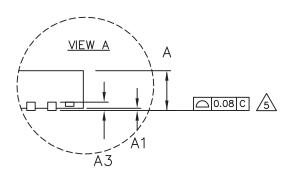


## 32-Pin QFN Package Option 3: MachXO2 SG32C

**Dimensions in Millimeters** 







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

 $\stackrel{\textstyle \frown}{}$  Applies to exposed portion of terminals.

6. JEDEC REFERENCE MO-248 AND DR-4.2

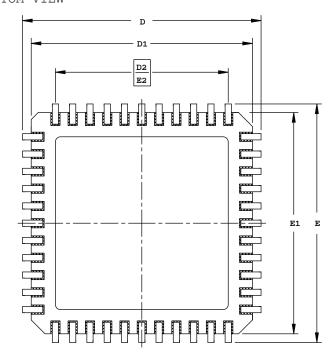
SYMBOL	MIN.	NOM.	MAX.
А	0.50	0.55	0.65
A1	0.00	0.02	0.05
А3		0.2 REF	
D		5.0 BSC	
D2	3.40	3.50	3.60
E	5.0 BSC		
E2	3.40	3.50	3.60
b	0.18	0.25	0.30
е	0.50 BSC		
L	0.35	0.40	0.45

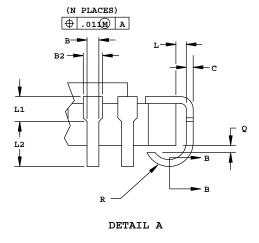


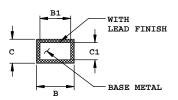
# 44-Pin JLCC Package

### Dimensions in Inches

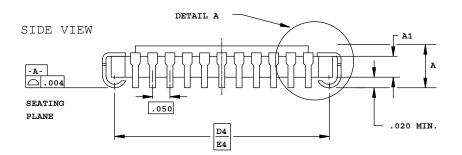
#### BOTTOM VIEW







SECTION B-B



### NOTES:

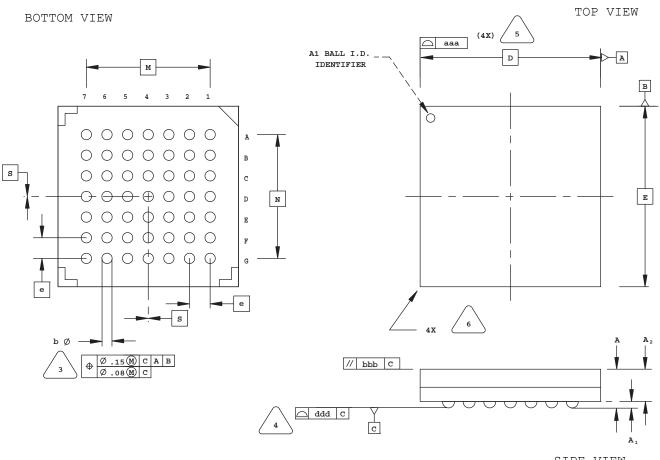
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- 3. CORNER CHAMFERS AND/OR NOTCHES ARE OPTIONAL.

S Y M	INCHES		
M B O L	MIN.		MAX.
A	.115	1	.190
<b>A1</b>	. 0	65 RE	F
В	.013	-	.023
B1	.013	ı	.020
B2	.022	-	.035
С	.007	ı	.013
C1	.007	ı	.010
D/E	.675	.690	.700
D1/E1	.620	ı	.660
D2/E2		00 BS	c
D4/E4	. 6	30 BS	C
L	.005	ı	-
L1	.020	-	-
L2	.025	ı	-
Q	.003	-	-
R	.020	-	.040
N		44	



## 49-Ball caBGA Package

### **Dimensions in Millimeters**



SIDE VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES 1. PER ANSI Y14.5M.
- ALL DIMENSIONS ARE IN MILLIMETERS. 2.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



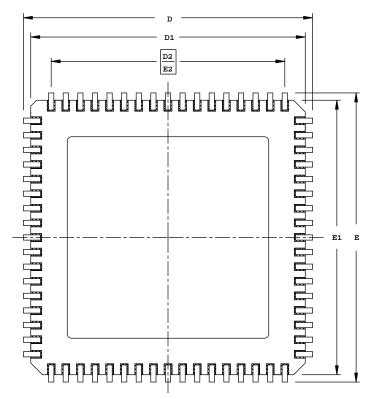
SYMBOL	MIN.	NOM.	MAX.	
A	1.30	1.40	1.50	
A1	0.31	0.36	0.41	
A2	0.99	1.04	1.09	
D/E	7	7.00 BSC		
M/N	4.80 BSC			
s		0 BSC		
b	0.40	0.46	0.52	
е	0	.80 BSC		
aaa	-	-	0.10	
bbb	-	-	0.10	
ddd	-	-	0.12	

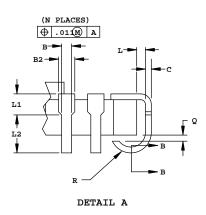


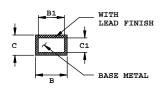
# 68-Pin JLCC Package

### Dimensions in Inches

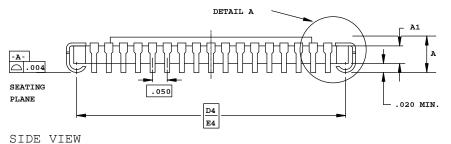
#### BOTTOM VIEW







SECTION B-B



#### NOTES:

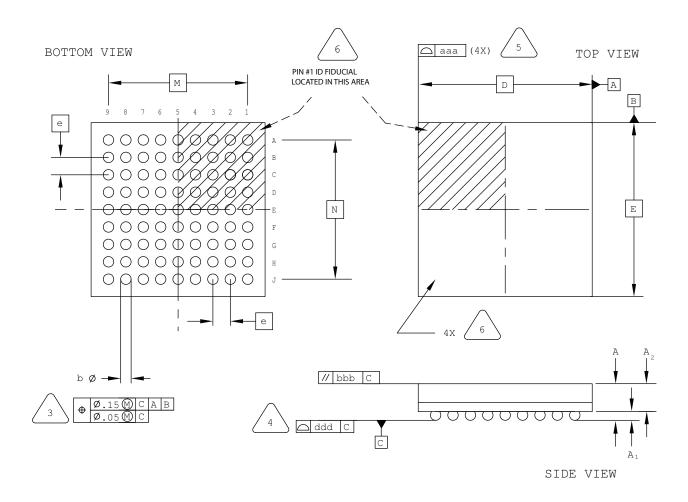
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- 3. CORNER CHAMFERS AND/OR NOTCHES ARE OPTIONAL.

S M B O L	INCHES MAX.		
o r			
A	.115	ı	.190
A1	. (	80 RE	F
В	.013	-	.023
B1	.013	-	.020
B2	.022	-	.035
С	.007	-	.013
C1	.007	-	.010
D/E	.975	.990	1.000
D1/E1	.920	1	.960
D2/E2	. 8	00 BS	С
D4/E4	. 9	30 BS	C
L	.005	-	-
L1	.020	-	-
L2	.025	-	-
Q	.003	•	1
R	.020	-	.040
N	68		



## 81-Ball csBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

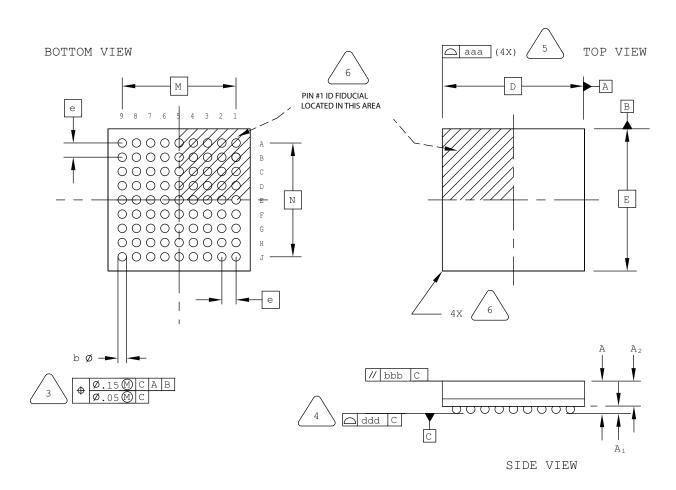


SYMBOL	MIN.	NOM.	MAX.
А	-	ı	1.00
A1	0.10	-	-
A2	-	-	0.90
D/E	5.00 BSC		
M/N	4.00 BSC		
b	0.20	0.25	0.30
е	0.50 BSC		
aaa	-	_	0.10
bbb	-	_	0.10
ddd	_	_	0.10



## 81-Ball ucBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

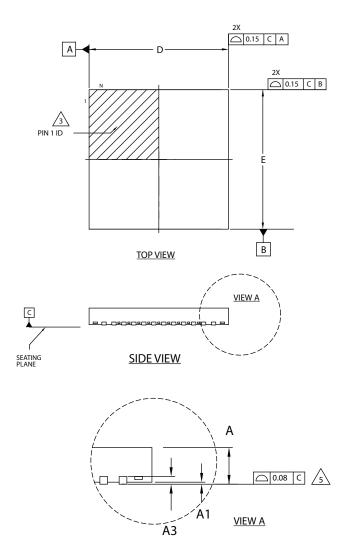


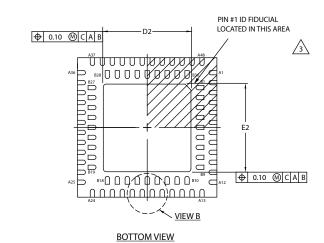
SYMBOL	MIN.	NOM.	MAX.	
А	-	-	1.00	
A1	0.10	_	-	
A2	1	-	0.90	
D/E	4.00 BSC			
M/N	3	3.20 BSC		
b	0.20	0.25	0.30	
е	0	0.40 BSC		
aaa	_	_	0.10	
bbb	-	_	0.10	
ddd	-	_	0.10	

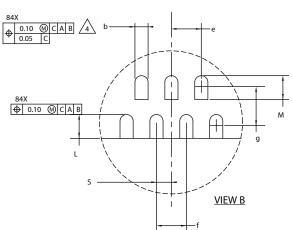


## 84-Pin QFN Package

### **Dimensions in Millimeters**







SYMBOL MIN. NOM. MAX. 0.75 0.95 0.85 Α1 0.00 0.02 0.05 АЗ 0.15 REF D 7.0 BSC D2 4.50 Ε 7.0 BSC E2 4.30 4.50 0.17 0.27 b 0.22 0.50 BSC f 0.50 BSC g 0.65 BSC S 0.25 BSC  $_{\rm L}$ 0.30 0.40 0.50 Μ 0.30 0.50 0.40

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{3}$ 

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.



DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

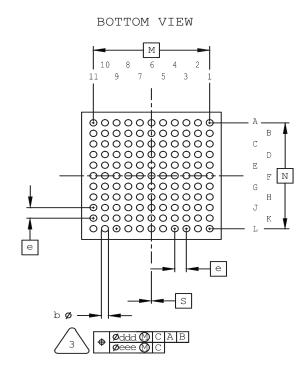


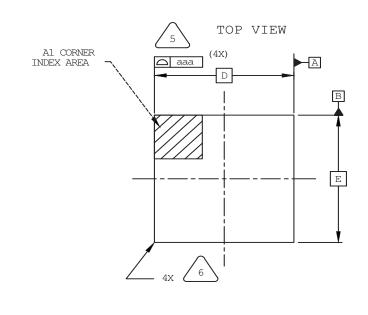
APPLIES TO EXPOSED PORTION OF TERMINALS.

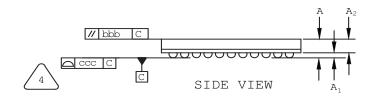


## 121-Ball csfBGA Package

### **Dimensions in Millimeters**







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C].



PRIMARY DATUM  $\overline{\mathbb{C}}$  AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

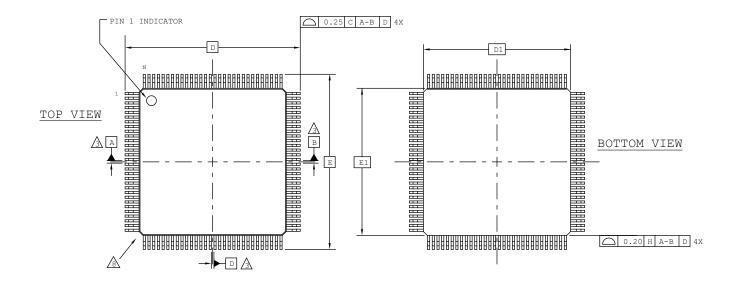


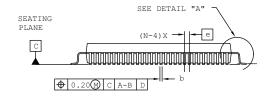
SYMBOL	MIN.	NOM.	MAX.
А	_	_	1.00
A1	0.15	0.24	-
A2	_	0.66	ı
D/E		6.00 BSC	
M/N		5.00 BSC	
S		0.00 BSC	
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	0.10		
bbb	0.10		
ccc	0.08		
ddd	0.15		
eee		0.05	

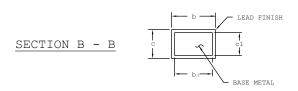


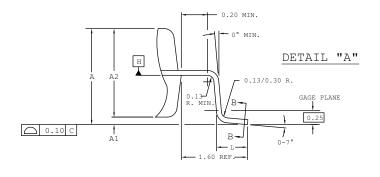
## 128-Pin PQFP Package

### **Dimensions in Millimeters**



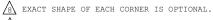






#### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
- A DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 D0 NOT INCLUDE MOLD PROTRUSION.
  ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6.0 SECTION B-B:
  THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE
  LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.



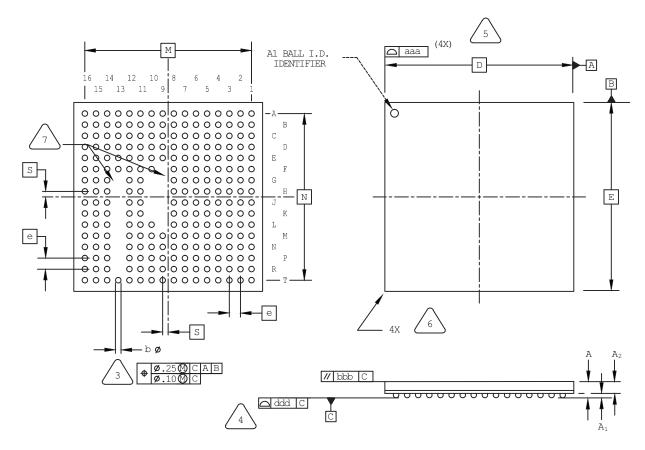
♠ EXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.
A	-	-	4.10
A1	0.25	-	0.50
A2	3.20	3.40	3.60
D		31.20 BSC	!
D1		28.00 BSC	!
E		31.20 BSC	!
E1		28.00 BSC	!
L	0.73	0.88	1.03
N	128		
е	0.80 BSC		
b	0.29	-	0.45
b1	0.29	0.35	0.41
С	0.11	-	0.23
c1	0.11	0.15	0.19



### 237-Ball ftBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.



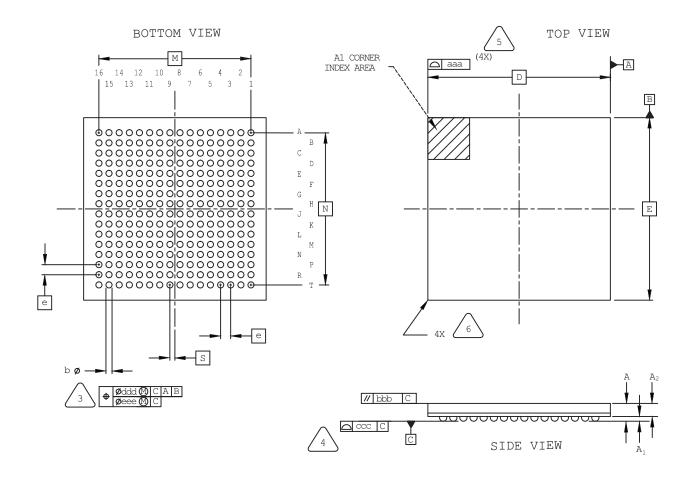
DEPOPULATED 13G TO 13R, 10G TO 10K, AND 9F TO 9L.

SYMBOL	MIN.	NOM.	MAX.
А	1.40	1.55	1.70
A1	0.30	-	-
A2	_	-	1.24
D/E	17.0 BSC		
M/N	15.0 BSC		
S	0.50 BSC		
b	0.40	0.50	0.60
е	1.0 BSC		
aaa	_	-	0.20
bbb	_	-	0.25
ddd	_	-	0.15



### 256-Ball csfBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM  $\boxed{\mathbb{C}}$ .



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

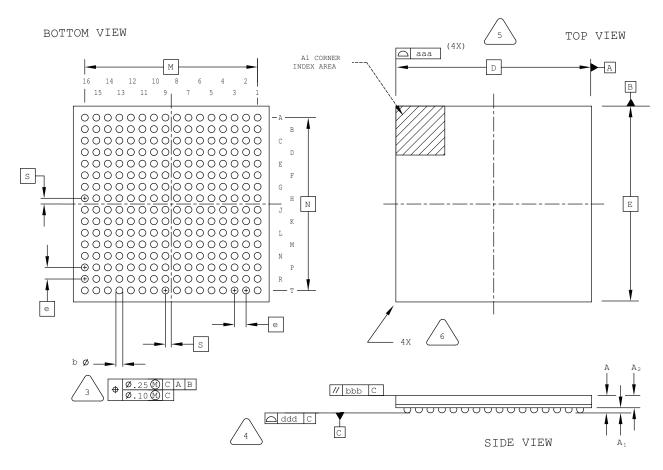


SYMBOL	MIN.	NOM.	MAX.	
А	-	-	1.00	
A1	0.15	0.24	_	
A2	ı	0.66	-	
D/E	9.00 BSC			
M/N	7.50 BSC			
S	0.25 BSC			
b	0.25 0.30 0.35			
е	0.50 BSC			
aaa	0.10			
bbb	0.10			
ccc	0.08			
ddd	0.15			
eee	0.05			



# 256-Ball ftBGA Package Option 2: LatticeECP3™

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM  $\square$ 



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

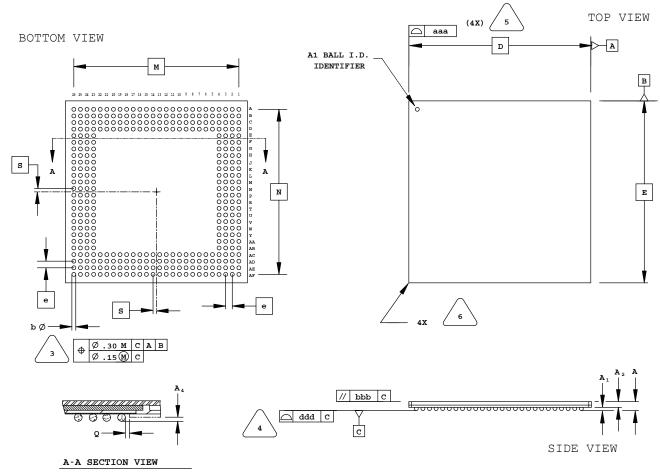


SYMBOL	MIN.	NOM.	MAX.
А	1.30	1.70	2.10
A1	0.30	0.50	0.70
A2	1.40 REF		
D/E	17.0 BSC		
M/N	15.0 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.0 BSC		
aaa	0.2		0.20
bbb	_	_	0.25
ddd	_	_	0.20



## 352-Ball SBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

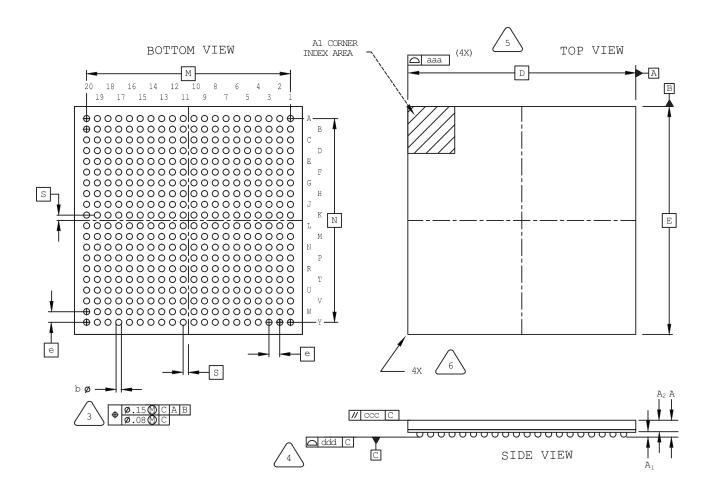


SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.70
A1	0.50	0.65	0.80
A2	0.80	0.90	1.00
D/E	35.00 BSC		
M/N	31.75 BSC		
s	0.635 BSC		
b	0.60	0.75	0.90
е	1.27 BSC		
Q	0.25	-	-
A4	0.10	-	-
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.20



### 400-Ball caBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM  $\boxed{\mathbb{C}}$ 



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

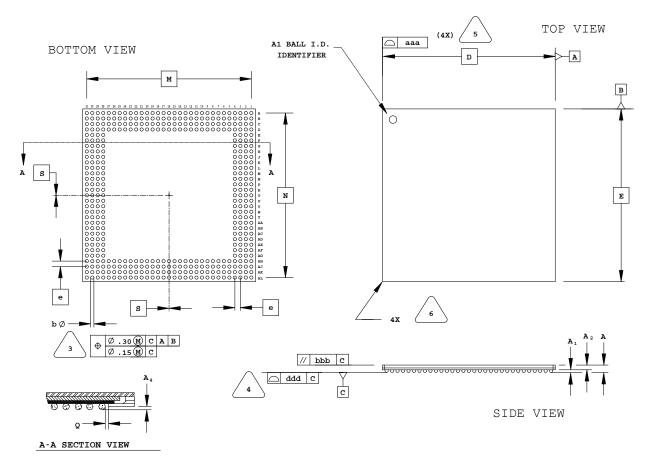


SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.70
A1	0.25	0.35	-
A2	0.80	1.00	_
D/E	17.0 BSC		
M/N	15.2 BSC		
S	0.40 BSC		
b	0.40	0.45	0.50
е	0.80 BSC		
aaa	_	_	0.15
ccc	_	_	0.20
ddd	_	_	0.20



## 432-Ball SBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

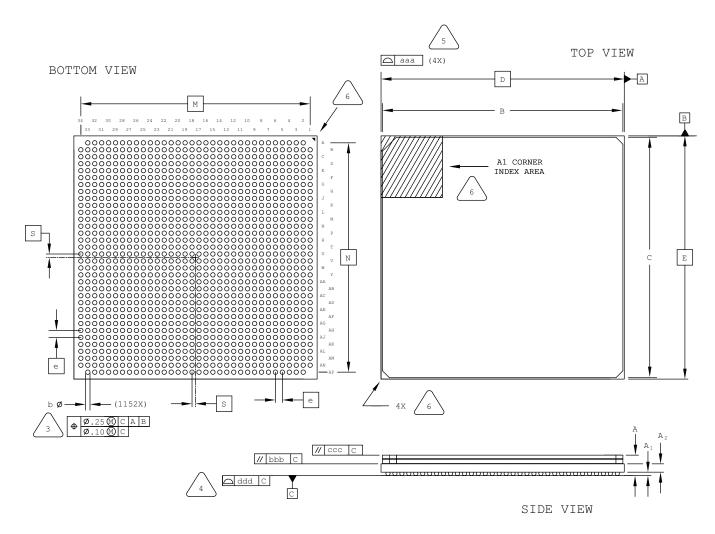


NOM 0.65 0.90 0.00 BSC 8.10 BSC	MAX. 1.70 0.80 1.00	
0.90 0.00 BSC	0.80	
0.90 0.00 BSC		
0.00 BSC	1.00	
8.10 BSC		
0.00 BSC		
0.75	0.90	
1.27 BSC		
-	-	
-	-	
-	0.20	
-	0.25	
-	0.20	
	0.00 BSC 0.75	



## 1152-Ball Organic fcBGA Package Option 2: LatticeSC/SCM80 & SC/SCM115

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

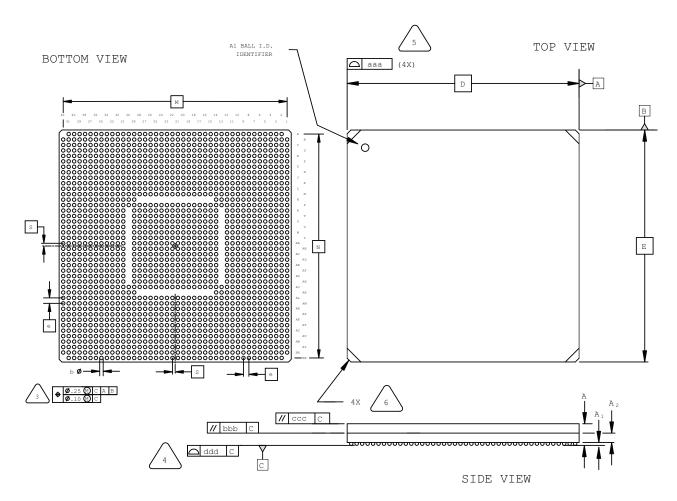


SYMBOL	MIN.	NOM.	MAX.
A	2.80	3.15	3.50
A1	0.35	0.50	0.65
A2	1.20 REF		
B/C	34.30	34.60	34.90
D/E	35.00 BSC		
M/N	33.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	_	0.25
ccc	-	_	0.35
ddd	_	_	0.23



## 1704-Ball Ceramic fcBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY. PACKAGE BODY INCLUDES SUBSTRATE AND LID.





SYMBOL	MIN.	NOM.	MAX.
A	4.30	4.80	5.30
A1	0.30	0.50	0.70
A2	1.30	1.60	1.90
D/E	42.50 BSC		
M/N	41.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	1	_	0.20
bbb			0.25
ccc	-	-	0.35
ddd	-	-	0.20